1/23/6	02-01-		
Form PTO-1595	REC 103171	SHEET U.S. DEPARTMENT OF CO)MMERCE
OMB No. 6514-0011(exp~4/94) IS-US050013	103171		
	ssioner of Patents and Tradema	the attached original Documents or copy	thereof.
 Name of conveying party(ies): (1) Yukio NAKAGAWA (2) Yoshio IWASAKI (3) Taro HIJIKATA Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No 		Name and address of receiving party(ies) Name: ISHIDA CO., LTD. Internal Address:	010
3. Nature of conveyance:			2.6% 4.0%
	Merger Merger	Street Address: 44, Sanno-cho, Shogoin	
Security Agreement	☐ Change of Name	City: Kyoto Prefecture: Kyot o Country Japan ZIP: 606-8392	<u> </u>
Other		Additional name(s) & address(es) attached? ☐ Yes ☒ No	
Execution Date: (1)(2)(3): 01/17/2006			
4. Application number(s) or p If this document is being fi 01/17/2006	` '	cation, the execution date of the application is: (1)(2)	(3):
A. Patent Application No.(s)		B. Patent No.(s)	
1/25/2006 SHASSEN1 00000093 1133 4 FC:8021	40.00 OFAdditional Application nur	nbers attached? ☐ Yes ⊠ No	
Name and address of party to whom correspondence concerning document should be mailed:		6. Total number of applications and patents involve	ed: 1
Name: Shinjyu Global IP Couns Internal Address:	elors, LLP	7. Total fee (37 CFR 3.41) :\$ 40.00 ⊠ Enclosed	
		Authorized to be charged to deposit account	
Street Address: 1233 Two	·	8. Deposit account number:	
City: Washington State: D.C. ZIP: 20036		(Attach duplicate copy of this page if paying by deposit account)	
	DO NOT US	SE THIS SPACE	
Statement and signature			

Mail documents to be recorded with required cover sheet Information to: Commissioner of Patents & Trademarks, Box Assignments

Signature Total number of pages including cover sheet, attachments, and document: | 2

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the

Washington, D.C. 20231

G:\01-JAN06-MT\IS-US050013 Assignment cover.doc

original document.

Kiyoe K. Kabashima Name of Person Signing

ASSIGNMENT

[Executed in Japan] WHEREAS, Yukio NAKAGAWA , a citizen of Japan, whose address is			
c/o ISHIDA CO., LTD. Shiga Integrated Facility, 959-1, Shimomagari, Ritto-shi, Shiga 520-3026,			
Japan,			
Yoshio IWASAKI, a citizen of Japan, whose address is			
c/o ISHIDA CO., LTD. Shiga Integrated Facility, 959-1, Shimomagari, Ritto-shi, Shiga 520-3026,			
<u>Japan</u> ,			
Taro HIJIKATA , a citizen of Japan, whose address is c/o ISHIDA CO., LTD. Shiga Integrated Facility, 959-1, Shimomagari, Ritto-shi, Shiga 520-3026,			
Japan			
hereinafter referred to as the Assignor(s), have invented certain new and useful improvements in			
PACKAGING APPARATUS AND PACKAGING SYSTEM INCLUDING THE SAME			
for which the Assignor(s) have executed an Application for United States Letters Patent			
(X) executed concurrently herewith			
() Serial No Filed			
, AND WHEREAS, ISHIDA CO., LTD. having its principal place			
of business at 44, Sanno-cho, Shogoin, Sakyo-ku, Kyoto-shi, Kyoto 606-8392, Japan			
(hereinafter referred to as the Assignee), is desirous of acquiring the entire right, title, and interest in			
and to said invention and said Application and in and to any Letters Patent or Patents, United			
States or foreign as indicated below, to be obtained therefor and thereon:			
NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is			
herewith acknowledged, the Assignor(s) sell, assign, and transfer, unto the Assignee, its successors,			
legal representatives and assigns, the entire right, title, and interest in the United States of America, and in all foreign countries including, but not limited to, the following countries,			
Great Britain			
in, to and under said improvements, and said Application, and all original, divisional, renewal,			
continuation, substitute, or reissue applications thereof, including the right to sue and recover for			
any past infringement, and all rights of priority from the filing of said Application; and the			
Assignor(s) hereby authorize and request the Commissioner of Patents and Trademarks to issue all			
Letters Patent on said improvements or resulting therefrom to said Assignee herein, as assignee of			
the entire interest therein, for the sole use and behalf of said Assignee, its successors, and assigns,			
to the full end of the term or terms for which Letters Patent or Patents may be granted.			
Further, the Assignor(s) and their legal representatives, heirs, and assigns do hereby agree and covenant without further remuneration that they will communicate to said Assignee, its successors,			
legal representatives and assigns, any facts known to them respecting said improvements whenever			
requested, and will testify in any interferences or other legal proceeding in which any of said			
applications or Letters Patent may become involved, sign all lawful papers, execute and deliver all			
divisional, continuing, reissue and other applications for Letters Patent on said improvements and			
all assignments thereof to said Assignee or its legal representatives, successors, or assigns, make all			
rightful oaths and generally do everything necessary to assist said Assignee, its successors, legal			
representatives and assigns, to obtain and enforce proper patent protection for said improvements in			
the U.S. and said countries, the expenses incident to said applications to be borne and paid by said assignee.			
assignee.			
The undersigned hereby grants the firm of Shinjyu Global IP Counselors, LLP the power to insert in			
this Assignment any further identification which may be necessary or desirable to comply with the			
rules of the U.S. Patent and Trademark Office for recordation of this Assignment.			
IN TESTIMONY WHEREOF, the undersigned Assignor(s) have affixed their signatures.			
This 17 day of JAX 2006 Signature Yusura Makagawa			
This 17th day of Jan., 2006 Signature Mashie Imasch			
This			

PATENT REEL: 017499 FRAME: 0286

RECORDED: 01/23/2006